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Kind regards,

Team Nexperia



PMBT3906VS

40 V, 200 mA PNP/PNP switching transistor Rev. 01 — 20 August 2009

Product data sheet

Product profile

1.1 General description

PNP/PNP double switching transistor in a SOT666 ultra small and flat lead Surface-Mounted Device (SMD) plastic package.

Table 1. Product overview

Type number	Package		NPN/NPN	NPN/PNP
	NXP	JEITA	complement	complement
PMBT3906VS	SOT666	-	PMBT3904VS	PMBT3946VPN

1.2 Features

- Double general-purpose switching transistor
- Board-space reduction
- AEC-Q101 qualified
- Ultra small and flat lead SMD plastic package

1.3 Applications

■ General-purpose switching and amplification

1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor					
V_{CEO}	collector-emitter voltage	open base	-	-	-40	V
I _C	collector current		-	-	-200	mA
h _{FE}	DC current gain	$V_{CE} = -1 V;$ $I_{C} = -10 \text{ mA}$	100	180	300	



2. Pinning information

Table 3. Pinning

Table 5.	i iiiiiiig		
Pin	Description	Simplified outline	Graphic symbol
1	emitter TR1		
2	base TR1	6 5 4	6 5 4
3	collector TR2		TR2
4	emitter TR2		(TR1)
5	base TR2	1 2 3	
6	collector TR1	1 2 3	1 2 3
			sym018

3. Ordering information

Table 4. Ordering information

Type number	Package		
	Name	Description	Version
PMBT3906VS	-	plastic surface-mounted package; 6 leads	SOT666

4. Marking

Table 5. Marking codes

Type number	Marking code
PMBT3906VS	ZD

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per trans	istor				
V_{CBO}	collector-base voltage	open emitter	-	-40	V
V_{CEO}	collector-emitter voltage	open base	-	-40	V
V_{EBO}	emitter-base voltage	open collector	-	-6	V
I _C	collector current		-	-200	mA
I _{CM}	peak collector current	single pulse; $t_p \le 1 \text{ ms}$	-	-200	mA
I _{BM}	peak base current	single pulse; $t_p \le 1 \text{ ms}$	-	-100	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 ^{\circ}C$	[1][2]	240	mW
Per devic	ee				
P _{tot}	total power dissipation	$T_{amb} \le 25 ^{\circ}C$	[1][2]	360	mW

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40 V, 200 mA PNP/PNP switching transistor

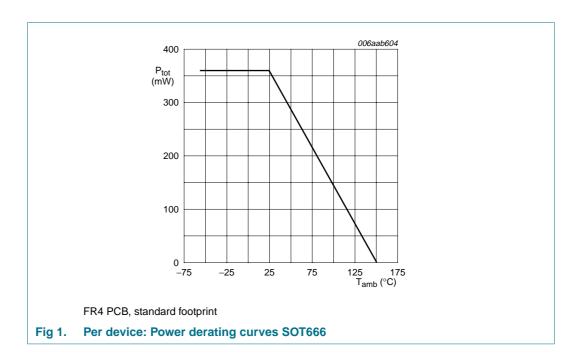
Limiting values ...continued Table 6.

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
T_j	junction temperature		-	150	°C
T _{amb}	ambient temperature		-55	+150	°C
T _{stg}	storage temperature		-65	+150	°C

Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard

[2] Reflow soldering is the only recommended soldering method.



Thermal characteristics

Product data sheet

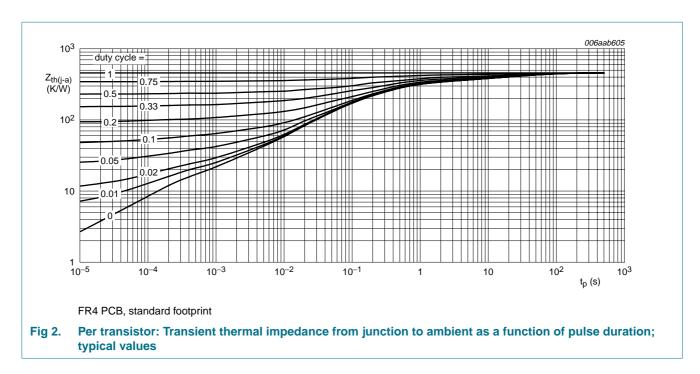
Table 7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor					
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1][2]	-	521	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		-	-	100	K/W
Per devic	е					
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1][2]	-	347	K/W

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

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^[2] Reflow soldering is the only recommended soldering method.



7. Characteristics

Table 8. Characteristics

 T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor					
I _{CBO}	collector-base cut-off current	$V_{CB} = -30 \text{ V}; I_E = 0 \text{ A}$	-	-	-50	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = -6 \text{ V}; I_C = 0 \text{ A}$	-	-	-50	nA
h _{FE}	DC current gain	$V_{CE} = -1 V$				
		$I_{\rm C} = -0.1 \text{mA}$	60	180	-	
		$I_C = -1 \text{ mA}$	80	180	-	
		$I_C = -10 \text{ mA}$	100	180	300	
		$I_C = -50 \text{ mA}$	60	130	-	
		$I_{C} = -100 \text{ mA}$	30	50	-	
V_{CEsat}	collector-emitter	$I_C = -10 \text{ mA}; I_B = -1 \text{ mA}$	-	-100	-250	mV
	saturation voltage	$I_C = -50 \text{ mA}; I_B = -5 \text{ mA}$	-	-165	-400	mV
V_{BEsat}	base-emitter	$I_C = -10 \text{ mA}; I_B = -1 \text{ mA}$	-	-750	-850	mV
	saturation voltage	$I_C = -50 \text{ mA}; I_B = -5 \text{ mA}$	-	-850	-950	mV
t _d	delay time	$V_{CC} = -3 \text{ V};$	-	-	35	ns
t _r	rise time	$I_C = -10 \text{ mA};$	-	-	35	ns
t _{on}	turn-on time	$I_{Bon} = -1 \text{ mA};$ $I_{Boff} = 1 \text{ mA}$	-	-	70	ns
t _s	storage time		-	-	225	ns
t _f	fall time		-	-	75	ns
t _{off}	turn-off time		-	-	300	ns

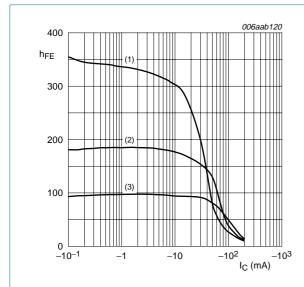
PMBT3906VS_1

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Table 8. Characteristics ...continued

 T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C _c	collector capacitance	$V_{CB} = -5 \text{ V; } I_E = i_e = 0 \text{ A;}$ f = 1 MHz	-	-	4.5	pF
C _e	emitter capacitance	$V_{EB} = -500 \text{ mV};$ $I_C = i_c = 0 \text{ A}; f = 1 \text{ MHz}$	-	-	10	pF
f _T	transition frequency	$V_{CE} = -20 \text{ V};$ $I_{C} = -10 \text{ mA};$ f = 100 MHz	250	-	-	MHz
NF	noise figure	$V_{CE} = -5 \text{ V};$ $I_{C} = -100 \mu\text{A}; R_{S} = 1 \text{ k}\Omega;$ f = 10 Hz to 15.7 kHz	-	-	4	dB



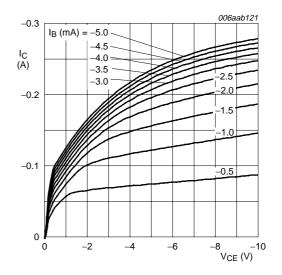


- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

Fig 3. Per transistor:

Product data sheet

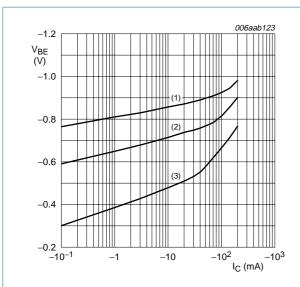
DC current gain as a function of collector current; typical values



 $T_{amb} = 25 \, ^{\circ}C$

Per transistor: Fig 4.

Collector current as a function of collector-emitter voltage; typical values



$$V_{CE} = -1 V$$

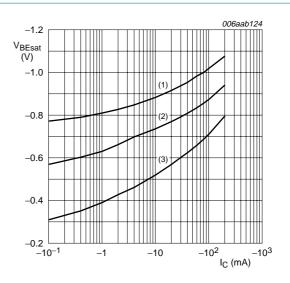
(1)
$$T_{amb} = -55 \,^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3) $T_{amb} = 150 \, ^{\circ}C$

Fig 5. Per transistor:

Base-emitter voltage as a function of collector current; typical values



$$I_{\rm C}/I_{\rm B} = 10$$

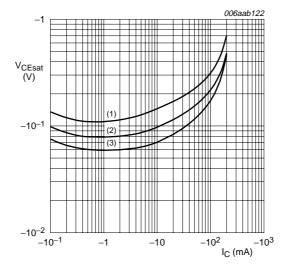
(1)
$$T_{amb} = -55 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = 150 \, ^{\circ}C$$

Fig 6. Per transistor:

Base-emitter saturation voltage as a function of collector current; typical values



$$I_{\rm C}/I_{\rm B}=10$$

(1)
$$T_{amb} = 150 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

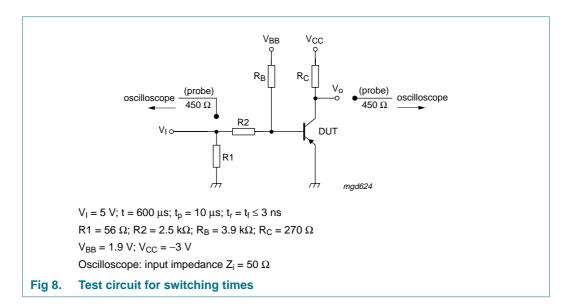
(3) $T_{amb} = -55 \, ^{\circ}C$

Fig 7. Per transistor: Collector-emitter saturation voltage as a function of collector current; typical values

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40 V, 200 mA PNP/PNP switching transistor

Test information

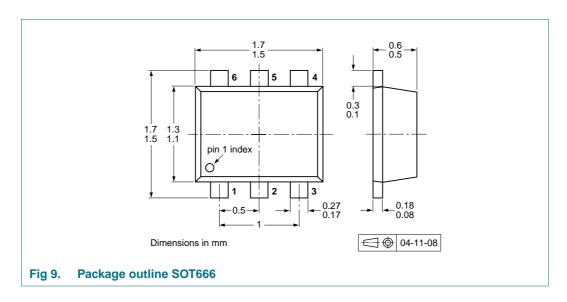


8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

Package outline 9.

Product data sheet



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10. Packing information

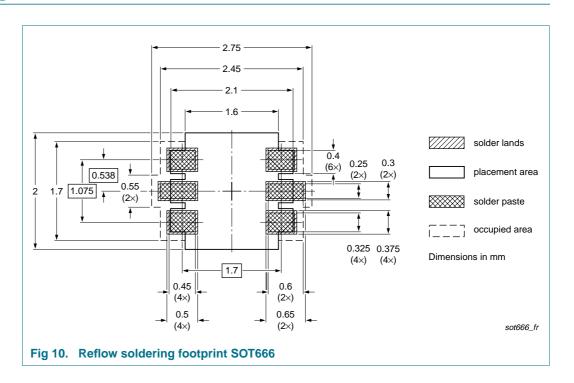
Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantity	
			4000	8000
PMBT3906VS	SOT666	2 mm pitch, 8 mm tape and reel	-	-315
	4 mm pitch, 8 mm tape and reel	-115	-	

^[1] For further information and the availability of packing methods, see Section 14.

11. Soldering





12. Revision history

Table 10. Revision history

Product data sheet

Document ID	Release date	Data sheet status	Change notice	Supersedes
PMBT3906VS_1	20090820	Product data sheet	-	-

13. Legal information

13.1 **Data sheet status**

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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PMBT3906VS

40 V, 200 mA PNP/PNP switching transistor

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